

ES3A THRU ES3M
Super Fast Recovery Rectifiers



Voltage: 50~1000 Volts

Current: 3 A

Package: SMB

Features

- NH'S Super Fast Recovery Rectifiers Chip Technology
- Low Switching Loss For High Efficiency
- Low Leakage Current For High Reliability
- Super Fast Switching Speed

Mechanical Data

- Case:** Molded With UL-94 ClassV-0 Recognized, RoHS-Compliant
- Polarity:** Look At The Diagram And Polarity On The Right
- Terminals:** Tin Plated Leads,Solderable Per J-STD-002 And JESD22-B102

Typical Applications

- Switch Mode Power Supplies (SMPS)
- Fast Chargers
- LED Driver And Monitor Lighting
- Automotive Electronics And Charging Posts

Diagram:



Polarity:



Single Phase,Half Wave,60Hz,Resistive Or Inductive Load.For Capacitive Load,Derate Current By 20%

Maximum Ratings (Ta=25°C Unless Otherwise Specified)

Parameter	Test Conditions	Symbol	ES 3A	ES 3B	ES 3D	ES 3G	ES 3J	ES 3K	ES 3M	Unit
Maximum Repetitive Peak Reverse Voltage		V_{RRM}	50	100	200	400	600	800	1000	V
Maximum RMS Voltag		V_{RMS}	35	70	140	280	420	560	700	V
Maximum DC Blocking Voltage		V_{DC}	50	100	200	400	600	800	1000	V
Maximum Average Forward Rectified Current		$I_{F(AV)}$	3							A
Peak Forward Surge Current	8.3ms Single Half Sine-wave Superimposed On Rate Load	I_{FSM}	100							A
Current Squared Time	$t < 8.3ms$	I^2t	41.5							A ² sec

Electrical Characteristics (Ta=25°C Unless Otherwise Specified)

Parameter	Test Conditions	Symbol	ES 3A	ES 3B	ES 3D	ES 3G	ES 3J	ES 3K	ES 3M	Unit
Maximum Instantaneous Forward Voltage	$I_F = 3.0 A$	V_F	0.95			1.25	1.68	1.95	3.50	V
Maximum DC Reverse Current at Rated DC Blocking Voltage	Ta=25°C, $V_R = V_{RRM}$ Ta=125°C, $V_R = V_{RRM} * 80\%$	I_{RRM}	5 200							uA uA
Typical Junction Capacitance	4 V,1MHz	C_J	60			35	29	21	18	pF
Maximum Reverse Recovery Time	$I_F = 0.5A$, $I_R = 1.0A$, $IRR = 0.25A$	T_{rr}	35							nS

Thermal Characteristics (Ta=25°C Unless Otherwise Specified)

Parameter	Test Conditions	Symbol	ES 3A	ES 3B	ES 3D	ES 3G	ES 3J	ES 3K	ES 3M	Unit
Operating Junction Temperature Range		T _J	-55~150							℃
Storage Temperature Range		T _{STD}	-55~150							
Thermal Resistance Junction To Ambient With Steady-State	Still Air Environment With Ta=25℃	R _{θJA}	65.0							℃/W
Thermal Resistance Junction-Case With Steady-State	Device Mounted On 1 in2 FR-4 Board With 2oz. Copper	R _{θJC}	17.0							

Notes: 1.Pulse Test: 300 Us Pulse Width,1% Duty Cycle

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Typical Characteristics Curves

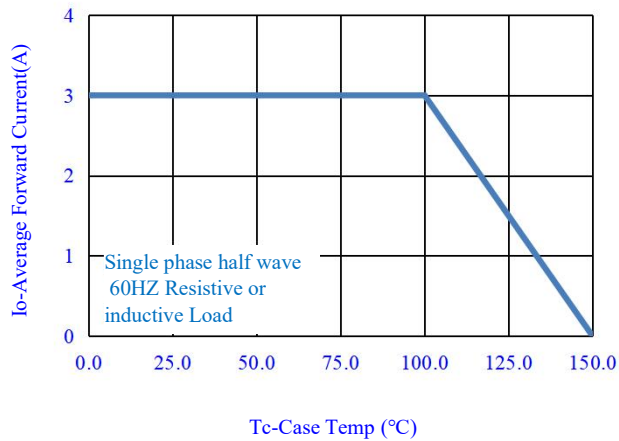


Fig.1-Forward Current Derating Curve

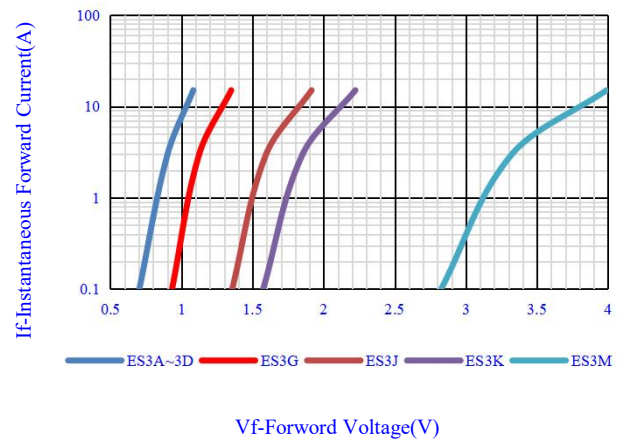


Fig.2-Typical Instantaneous Forward

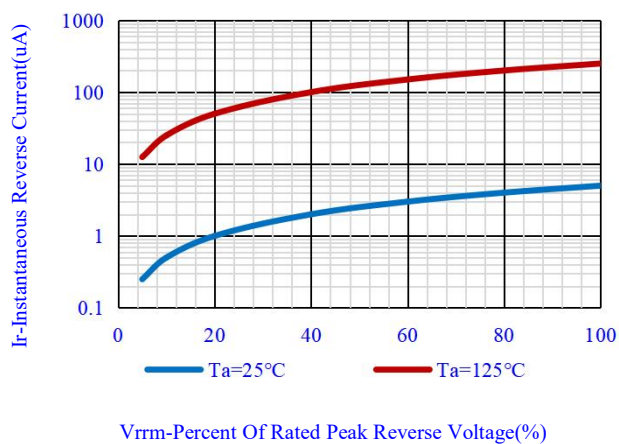


Fig.3-Typical Reverse Characteristics

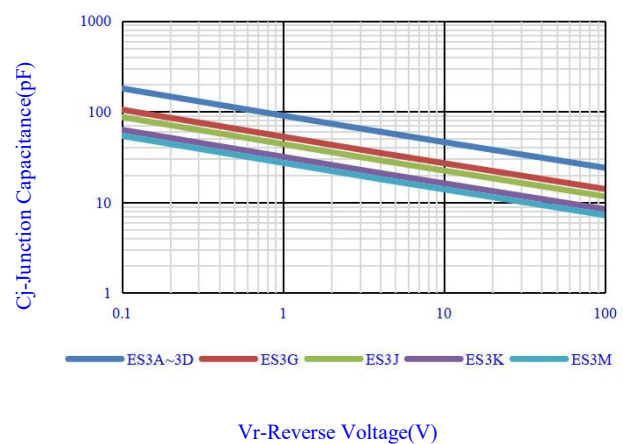


Fig.4-Typical Junction Capacitance

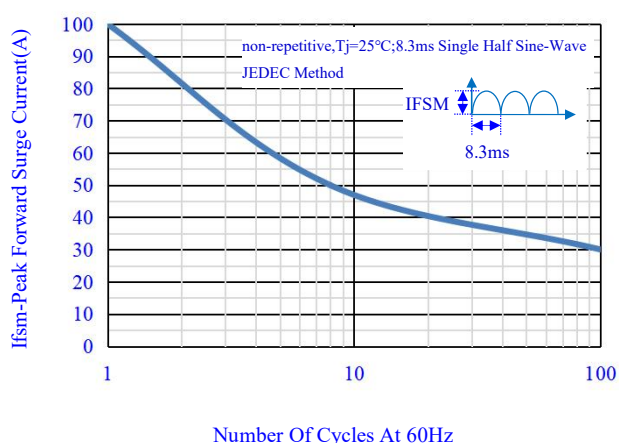


Fig.5-Max. Non-Repetitive Surge Current

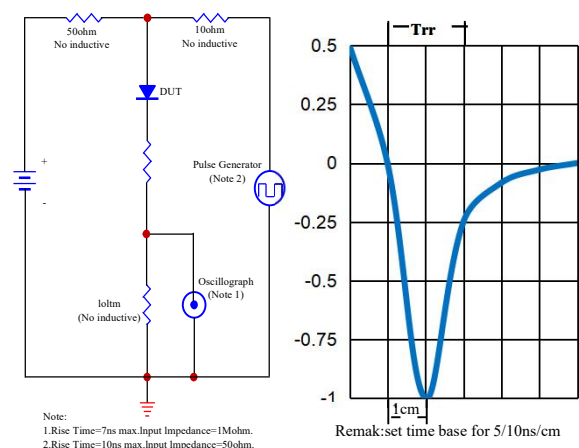
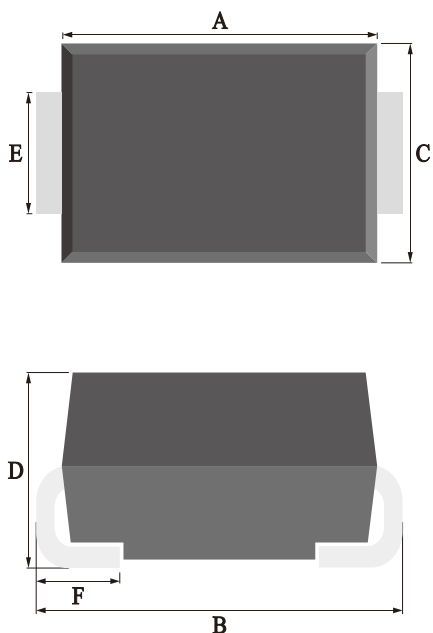


Fig.6-Reverse Recovery Time Characteristic And Test Circuit

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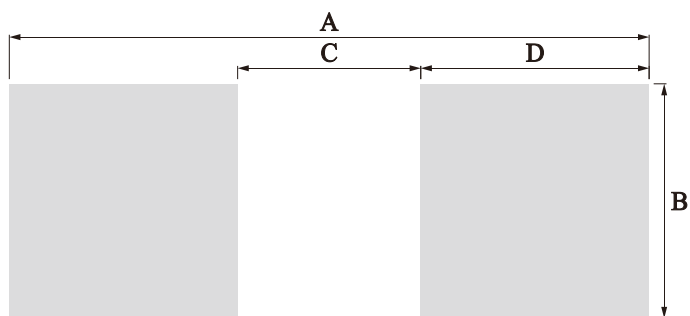
OUTLINE DRAWINGS



SMB

OUTLINE DIMENSIONS						
Dim.	Milimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A	4.00	-	4.70	0.1575	-	1.8504
B	5.00	-	5.59	1.9685	-	2.2008
C	3.30	-	3.94	1.2992	-	1.5512
D	2.10	-	2.45	0.8268	-	0.9646
E	1.90	-	2.11	0.7480	-	0.8307
F	0.76	-	1.50	0.2992	-	0.5906

RECOMMENDED LAYOUT DRAWINGS



SMB

OUTLINE DIMENSIONS						
Dim.	Milimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A	-	6.34	-	-	2.4961	-
B	-	2.72	-	-	1.0709	-
C	-	1.76	-	-	0.6929	-
D	-	2.29	-	-	0.9016	-

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MARKING



MARKING INSTRUCTION

NH=Niuhan Trademark
FF=Product Line Code,According To Actual Changes
YWW=Date Code,According To Actual Changes
ES3x=Model,xx=A,B,D,G,J,K,M
White band denotes cathode

PACKING INFORMATION

Package Type	Package Code	Product Weight Approx(g/Pcs)	Package Method	Quantity (Pcs/Min. Pack.)	Quantity (Pcs/Inner Box)	Quantity (Pcs/Carton)
SMB	P1	0.095	13" Reel	3000	6000	48000
SMB	P1	0.095	13" Reel	3000	6000	60000

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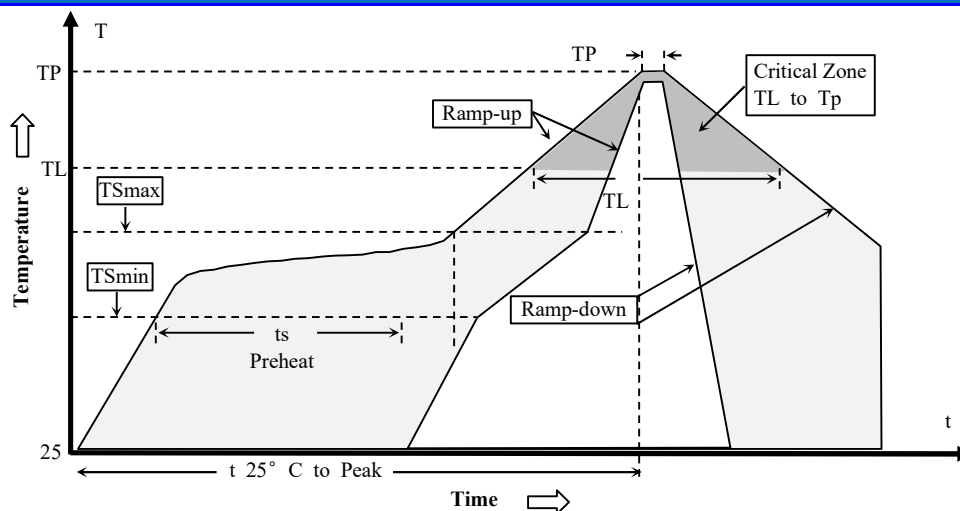
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Recommended wave soldering condition

Product	Peak Temperature	Soldering Time
Pb-free devices	260 +0/-5 °C	5 +1/-1 seconds

Recommended temperature profile for IR reflow



Profile feature	Sn-Pb eutectic Assembly	Pb-free Assembly
Average ramp-up rate (T _{smax} to T _p)	3°C/second max.	3°C/second max.
Preheat -Temperature Min(TS min) -Temperature Max(TS max) -Time(ts min to ts max)	100°C 150°C 60-120 seconds	150°C 200°C 60-180 seconds
Time maintained above: -Temperature (TL) - Time (tL)	183°C 60-150 seconds	217°C 60-150 seconds
Peak Temperature(TP)	240 +0/-5 °C	260 +0/-5 °C
Time within 5°C of actual peak temperature(tp)	10-30 seconds	20-40 seconds
Ramp down rate	6°C/second max.	6°C/second max.
Time 25 °C to peak temperature	6 minutes max.	8 minutes max.

Note : All temperatures refer to topside of the package, measured on the package body surface.

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